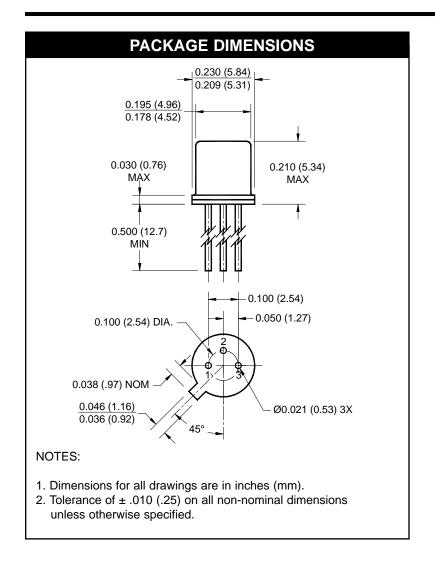
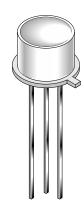
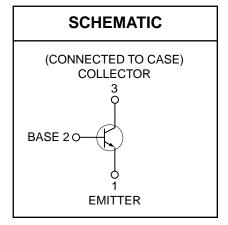


# L14N1 L14N2







### **DESCRIPTION**

The L14N1/L14N2 are silicon phototransistors mounted in a wide angle, TO-18 package.

### **FEATURES**

- · Hermetically sealed package
- Wide reception angle
- Device can be used as a photodiode by using the collector and base leads.



L14N1 L14N2

Parameter	Symbol	Rating	Unit	
Operating Temperature	T <sub>OPR</sub>	-65 to +125	°C	
Storage Temperature	T <sub>STG</sub>	-65 to +150	°C	
Soldering Temperature (Iron)(3,4,5 and 6)	T <sub>SOL-I</sub>	240 for 5 sec	°C	
Soldering Temperature (Flow)(3,4 and 6)	T <sub>SOL-F</sub>	260 for 10 sec	°C	
Collector to Emitter Breakdown Voltage	V <sub>CEO</sub>	30	V	
Collector to Base Breakdown Voltage	V <sub>CBO</sub>	40	V	
Emitter to Base Breakdwon Voltage	V <sub>EBO</sub>	5	V	
Power Dissipation (T <sub>A</sub> = 25°C) <sup>(1)</sup>	P <sub>D</sub>	300	mW	
Power Dissipation (T <sub>C</sub> = 25°C) <sup>(2)</sup>	P <sub>D</sub>	600	mW	

#### NOTE:

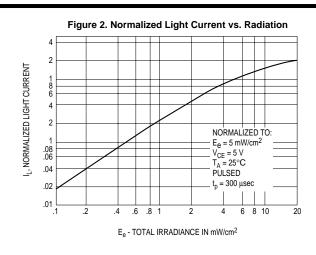
- 1. Derate power dissipation linearly 3.00 mW/°C above 25°C ambient.
- 2. Derate power dissipation linearly 6.00 mW/°C above 25°C case.
- 3. RMA flux is recommended.
- 4. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip 1/16" (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension.
- 7. Light source is a GaAs LED emitting light at a peak wavelength of 940 nm.
- 8. Figure 1 and figure 2 use light source of tungsten lamp at 2870°K color temperature. A GaAs source of 3.0 mW/cm² is approximately equivalent to a tungsten source, at 2870°K, of 10 mW/cm².

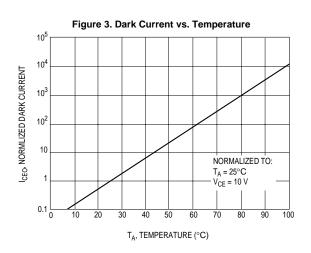
ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C) (All measurements made under pulse conditions)								
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	TYP	MAX	UNITS		
Collector-Emitter Breakdown	$I_{\rm C} = 10 \text{ mA}, Ee = 0$	BV <sub>CEO</sub>	30		_	V		
Emitter-Base Breakdown	I <sub>E</sub> = 100 μA, Ee = 0	BV <sub>EBO</sub>	5		_	V		
Collector-Base Breakdown	I <sub>C</sub> = 100 μA, Ee = 0	BV <sub>CBO</sub>	40		_	V		
Collector-Emitter Leakage	V <sub>CE</sub> = 10 V, Ee = 0	I <sub>CEO</sub>	_		100	nA		
Collector-Base leakage	V <sub>CB</sub> = 25 V, Ee = 0	I <sub>CBO</sub>			25	nA		
Reception Angle at 1/2 Sensitivity		θ		±40		Degrees		
On-State Collector Current L14N1	Ee = 0.5 mW/cm <sup>2</sup> , $V_{CE} = 5 V^{(7,8)}$	I <sub>C(ON)</sub>	1.0		_	mA		
On-State Collector Current L14N2	Ee = 0.5 mW/cm <sup>2</sup> , $V_{CE} = 5 V^{(7,8)}$	I <sub>C(ON)</sub>	2.0			mA		
On-State Photodiode Current	Ee = 1.5 mW/cm <sup>2</sup> , $V_{CB} = 5 V^{(7,8)}$	I <sub>CB(ON)</sub>		5.0		μΑ		
Rise Time	$I_C = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 100 \Omega$	t <sub>r</sub>		14		μs		
Fall Time	$I_{\rm C}$ = 10 mA, $V_{\rm CC}$ = 5 V, $R_{\rm L}$ =100 $\Omega$	t <sub>f</sub>		16		μs		
Saturation Voltage L14N1	$I_C = 0.8 \text{ mA}, Ee = 3.0 \text{ mW/cm}^{2(7,8)}$	V <sub>CE(SAT)</sub>	_		0.40	V		
Saturation Voltage L14N2	$I_C = 1.6 \text{ mA}, Ee = 3.0 \text{ mW/cm}^{2(7,8)}$	V <sub>CE(SAT)</sub>			0.40	V		

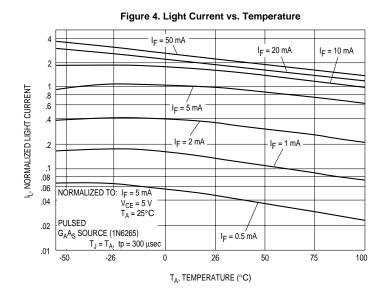


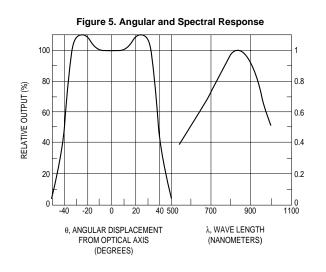
## L14N1 L14N2

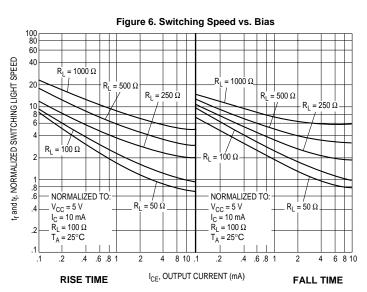
Figure 1. Light Current vs. Collector to Emitter Voltage NORMALIZED TO:  $E_e = 5 \text{ mW/cm}^2$ Fe = 20 mW/cm $V_{CE} = 5 V$   $T_A = 25^{\circ}C$ II, NORMALIZED LIGHT CURRENI PÜLSED  $Ee = 5 \text{ mW/cm}^2$  $t_{\rm D} = 300 \, \mu {\rm sec}$  $Fe = 2 \text{ mW/cm}^2$ Ee = 1 mW/cm<sup>2</sup>  $Ee = 0.5 \text{ mW/cm}^2$  $Ee = 0.2 \text{ mW/cm}^2$ .04 Ee = 0.1 mW/cm<sup>2</sup> .02  $V_{CE}$ , COLLECTOR TO EMITTER VOLTAGE (V)













L14N1 L14N2

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